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January 2014

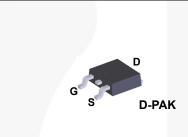
FQD12N20L **N-Channel QFET® MOSFET** 200 V, 9.0 A, 280 mΩ

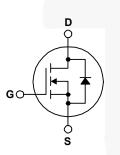
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 16 nC) resistance, and to provide superior switching performance . Low Crss (Typ. 17 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- 9.0 A, 200 V, R_{DS(on)} = 280 mΩ (Max.) @ V_{GS} = 10 V, I_D = 4.5 A





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

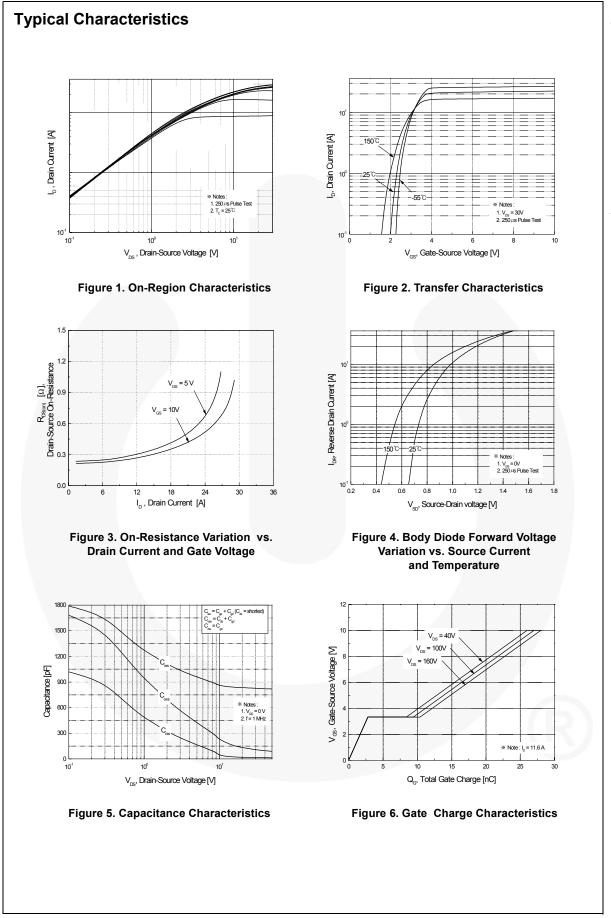
Symbol	Parameter		FQD12N20LTM	Unit
V _{DSS}	Drain-Source Voltage		200	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		9.0	А
	- Continuous (T _C = 100°C)		5.7	A
I _{DM}	Drain Current - Pulsed	(Note 1)	36	A
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	210	mJ
I _{AR}	Avalanche Current	(Note 1)	9.0	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
P _D	Power Dissipation ($T_A = 25^{\circ}C$) *		2.5	W
	Power Dissipation ($T_C = 25^{\circ}C$)		55	W
	- Derate above 25°C		0.44	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds		300	°C

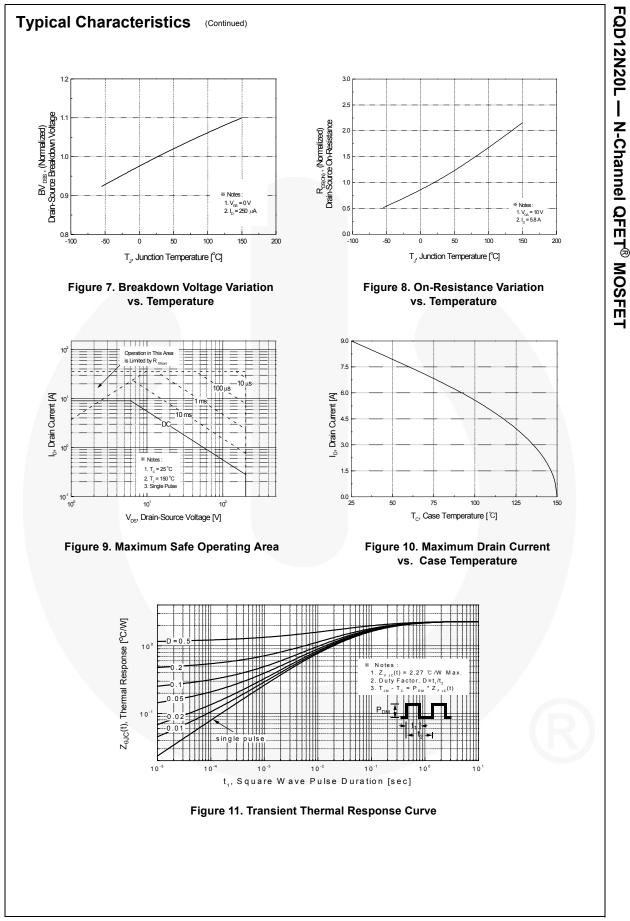
Thermal Characteristics

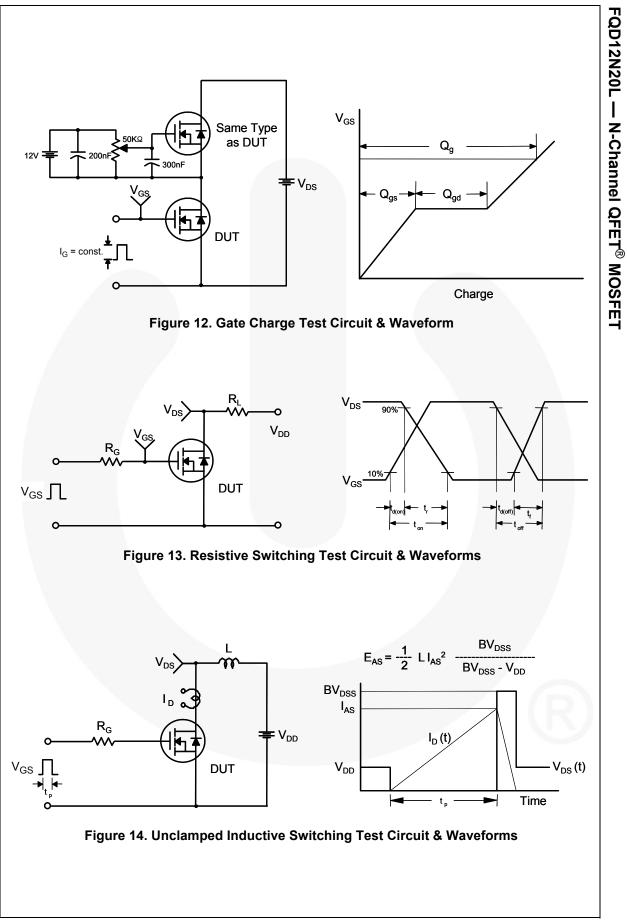
Symbol	Parameter	FQD12N20LTM	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	2.27	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	50	1

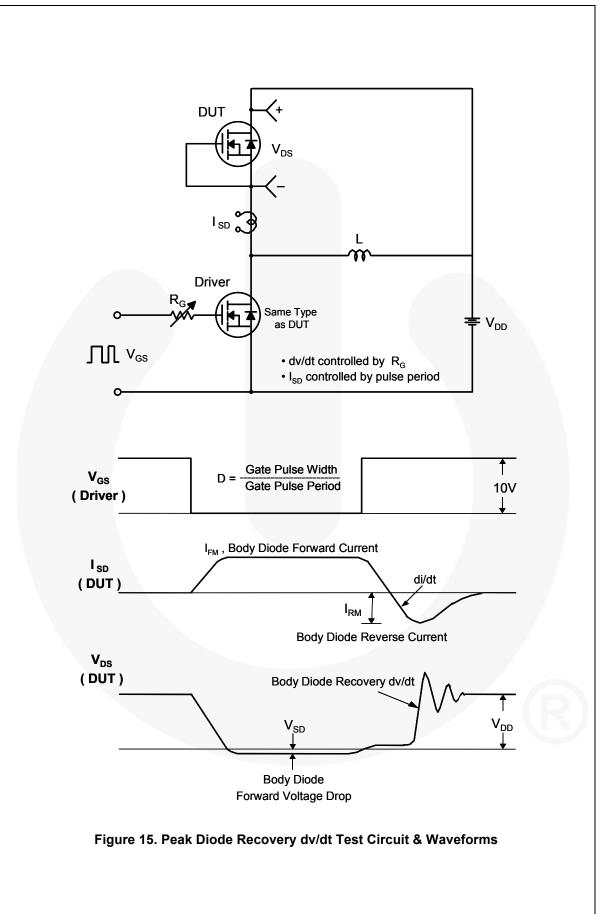
			DP	kagePacking MethodReePAKTape and Reel330		330		Tape Width 16 mm		Quantity 2500 units		
Symbol Off Cha ^{3V_{DSS} ABV_{DSS}}	cal Chai	D12N20LTM FQD12N20L D										
Dff Cha ^{3V} _{DSS} ABV _{DSS}		racteristics	T _C = 25°0	cunless ot	herwise noted.							
BV _{DSS}		Parameter			Test Cor	nditions		Min.	Тур.	Max.	Unit	
BV _{DSS}											-	
ABV _{DSS}			tage	Vee =	$0 V l_{p} = 2$	50 JJA		200			V	
	Drain-Source Breakdown Voltage Breakdown Voltage Temperature		V _{GS} = 0 V, I _D = 250 μA			200			V			
J	Coefficient	U 1	ture	I _D = 28	50 μA, Refe	erenced to	25°C		0.14		V/°C	
DSS	Zero Gate Voltage Drain Current Gate-Body Leakage Current, Forward		$V_{DS} = 200 V, V_{GS} = 0 V$ $V_{DS} = 160 V, T_C = 125^{\circ}C$					1	μA			
								10	μA			
GSSF			Forward		20 V, V_{DS}					100	nA	
GSSR	Gate-Body	/ Leakage Current,	Reverse	V _{GS} =	-20 V, V _{DS}	= 0 V				-100	nA	
On Cha	racterist	ics										
/ _{GS(th)}		Gate Threshold Voltage		V _{DS} =	V_{GS} , $I_D = 2$	250 μΑ		1.0		2.0	V	
R _{DS(on)}	Static Drai	n-Source		V _{GS} =	10 V, I _D =	4.5 A	- /		0.22	0.28	0	
	On-Resist	ance	_	V _{GS} =	5 V, I _D = 4	.5 A			0.25	0.32	Ω	
FS	Forward T	ransconductance		V _{DS} =	30 V, I _D =	4.5 A			11.6		S	
Jynami	ic Charac	toristics										
	Input Capa		-	V -	25 1/ 1/	- 0.)/			830	1080	pF	
S	Output Ca		_	f = 1.0	25 V, V _{GS}	= 0 V,			120	155	pF	
Crss		ransfer Capacitanc	e	1 - 1.0					17	22	pF	
100			-									
Switchi	ng Chara	octeristics										
Switchi				1				r				
d(on)	Turn-On D	5		V _{DD} =	100 V, I _D =	= 11.6 A,			15	40	ns	
d(on) r	Turn-On R	lise Time		V _{DD} = R _G = 2	100 V, I _D = 25 Ω	= 11.6 A,			190	390	ns ns	
d(on) r d(off)	Turn-On R Turn-Off D	tise Time Pelay Time			_		(Note 4)		190 60	390 130		
d(on) r d(off) f	Turn-On R Turn-Off D Turn-Off F	tise Time Jelay Time all Time	_	R _G = 2	25 Ω		(Note 4)		190 60 120	390 130 250	ns ns ns	
d(on) r d(off) f Q _g	Turn-On R Turn-Off D Turn-Off F Total Gate	tise Time lelay Time all Time Charge		R _G = 2	25 Ω 160 V, I _D =		(Note 4)	 	190 60 120 16	390 130 250 21	ns ns ns nC	
d(on) r d(off) f Q _g Q _{gs}	Turn-On R Turn-Off D Turn-Off F Total Gate Gate-Sour	tise Time elay Time all Time Charge ce Charge		R _G = 2	25 Ω 160 V, I _D =	: 11.6 A,			190 60 120 16 2.8	390 130 250 21 	ns ns nS nC nC	
d(on) r d(off) f Q _g Q _{gs}	Turn-On R Turn-Off D Turn-Off F Total Gate	tise Time elay Time all Time Charge ce Charge		R _G = 2	25 Ω 160 V, I _D =	: 11.6 A,	(Note 4) (Note 4)	 	190 60 120 16	390 130 250 21	ns ns ns nC	
$\frac{d(on)}{r}$ $\frac{d(off)}{f}$ $\frac{\lambda_g}{\lambda_{gs}}$ $\frac{\lambda_{gd}}{\lambda_{gd}}$	Turn-On R Turn-Off D Turn-Off F Total Gate Gate-Sour Gate-Drain	tise Time elay Time all Time Charge ce Charge n Charge	istics a	$R_G = 2$ $V_{DS} =$ $V_{GS} =$	25 Ω 160 V, I _D = 5 V	: 11.6 A,		 	190 60 120 16 2.8	390 130 250 21 	ns ns nS nC nC	
d(on) r d(off) f Q _g Q _{gs} Q _{gd} Drain-S	Turn-On R Turn-Off D Turn-Off F Total Gate Gate-Sour Gate-Drain	tise Time elay Time all Time Charge ce Charge		$R_G = 2$ $V_{DS} =$ $V_{GS} =$	25 Ω 160 V, I _D = 5 V ximum F	: 11.6 A, Ratings		 	190 60 120 16 2.8	390 130 250 21 	ns ns nS nC nC	
d(on) r d(off) f Q _g Q _{gs} Q _{gd} Drain-S S	Turn-On R Turn-Off D Turn-Off F Total Gate Gate-Sour Gate-Drain Gate-Drain Maximum	tise Time elay Time all Time Charge ce Charge n Charge ode Character	Source Dic	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ $N_{GS} =$	25 Ω 160 V, I _D = 5 V ximum F vard Currer	: 11.6 A, Ratings			190 60 120 16 2.8 7.6	390 130 250 21 	ns ns nC nC nC	
d(on) r d(off) f Q _{gs} Q _{gs} Q _{gd} Drain-S s SM	Turn-On R Turn-Off D Turn-Off F Total Gate Gate-Sour Gate-Drain Cource Di Maximum Maximum	tise Time elay Time all Time Charge the Charge the Charge ode Character Continuous Drain-	Source Dic ce Diode F	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ $N_{GS} =$	25 Ω 160 V, I _D = 5 V ximum F vard Currer	: 11.6 A, Ratings		 	190 60 120 16 2.8 7.6	390 130 250 21 9.0	ns ns nC nC nC A	
$\frac{d(on)}{r}$ $\frac{d(off)}{f}$ $\frac{2g}{ggs}$ $\frac{2gg}{ggd}$	Turn-On R Turn-Off D Turn-Off F Total Gate Gate-Sour Gate-Drain Ource Di Maximum Maximum Drain-Sou	tise Time elay Time all Time Charge the Charge the Charge ode Character Continuous Drain-Sour	Source Dic ce Diode F	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ $M_{GS} =$ $M_{GS} =$ $V_{GS} =$ $V_{GS} =$	25 Ω 160 V, I _D = 5 V kimum F vard Current	atings atings nt .0 A 1.6 A,		 	190 60 120 16 2.8 7.6	390 130 250 21 9.0 36	ns ns nC nC nC A A	

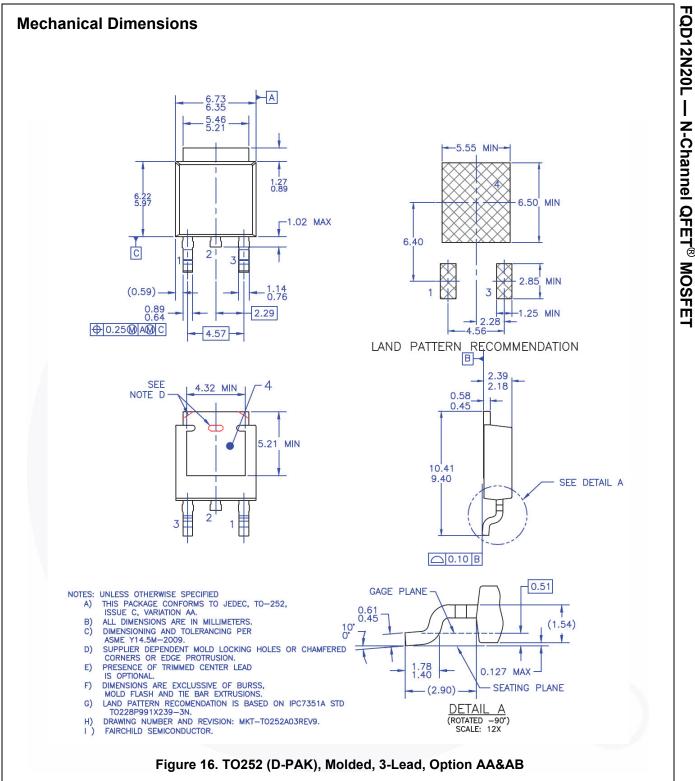
FQD12N20L — N-Channel QFET[®] MOSFET











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